

PM9A1 FW Change Notification

2022. Nov

Memory Business, Quality Assurance Division

THIS DOCUMENT AND ALL INFORMATION PROVIDED HEREIN (COLLECTIVELY, "INFORMATION") IS PROVIDED ON AN "AS IS" BASIS AND REMAINS THE SOLE AND EXCLUSIVE PROPERTY OF SAMSUNG ELECTRONICS CO., LTD. CUSTOMER MUST KEEP ALL INFORMATION IN STRICT CONFIDENCE AND TRUST, AND MUST NOT, DIRECTLY OR INDIRECTLY, IN ANY WAY, DISCLOSE, MAKE ACCESSIBLE, POST ON A WEBSITE, REVEAL, REPORT, PUBLISH, DISSEMINATE OR TRANSFER ANY INFORMATION TO ANY THIRD PARTY. CUSTOMER MUST NOT REPRODUCE OR COPY INFORMATION, WITHOUT SPECIFIC WRITTEN CONSENT FROM SAMSUNG. CUSTOMER MUST NOT USE, OR ALLOW USE OF, ANY INFORMATION IN ANY MANNER WHATSOEVER, EXCEPT FOR CUSTOMER'S INTERNAL EVALUATION PURPOSE. CUSTOMER MUST RESTRICT ACCESS TO INFORMATION TO THOSE OF ITS EMPLOYEES WHO HAVE A BONA FIDE NEED-TO-KNOW FOR SUCH PURPOSE AND ARE BOUND BY OBLIGATIONS AT LEAST AS RESTRICTIVE AS THIS CLAUSE. BY RECEIVING THIS DOCUMENT, IT IS UNDERSTOOD THAT CUSTOMER AGREES TO THE FOREGOING AND TO INDEMNIFY SAMSUNG FOR ANY FAILURE TO STRICTLY COMPLY THEREWITH. IF YOU DO NOT AGREE TO ANY PORTION OF THIS CLAUSE, PLEASE RETURN ALL INFORMATION AND ALL COPIES (IF ANY) WITHIN 24 HOURS OF RECEIPT THEREOF.

Contents

1. Background

- 1) Purpose
- 2) Samsung Qualification Schedule

2. Affected Product

3. Detailed of Changes

- **Purpose : Samsung PM9A1 NVMe SSD F/W Change to 78 version**
- **Reason of change**
 - Fix side effect of 77version FW (* Samsung officially informed to hold 77ver)
- **Samsung internal schedule**
 - Samsung internal Qualification : Nov-16th-2022
 - Release schedule : : Nov-16th-2022

■ PM9A1 P/N & New FW information

Product	Density	Samsung P/N	Current Firmware	Hold Firmware	New Firmware
M.2 (SED)	256GB	MZVL2256HCHQ-00B07	GXA7602Q	GXA7702Q	GXA7802Q
	512G	MZVL2512HCJQ-00B07			
	1TB	MZVL21T0HCLR-00B07	GXB7602Q	GXB7702Q	GXB7802Q
	2TB	MZVL22T0HBLB-00B07			
M.2 (non SED)	256GB	MZVL2256HCHQ-00A00	GXA7601Q	GXA7701Q	GXA7801Q
		MZVL2256HCHQ-00B00			
	512G	MZVL2512HCJQ-00A00			
		MZVL2512HCJQ-00B00			
	1TB	MZVL21T0HCLR-00A00	GXB7601Q	GXB7701Q	GXB7801Q
		MZVL21T0HCLR-00B00			
	2TB	MZVL22T0HBLB-00A00			
		MZVL22T0HBLB-00B00			

■ FW change List (From ver.77 to ver.78)

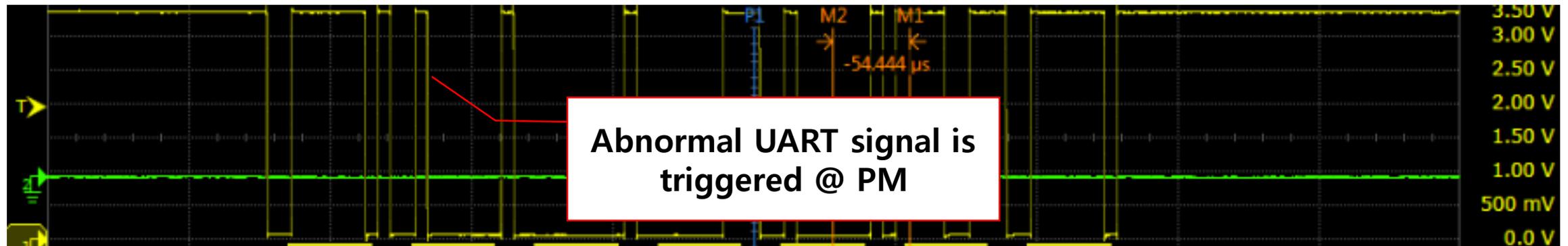
- Samsung would like to improve FW Quality through FW Change notification.

No.	Item	Change item	Risk Assessment
1	Fix FW for power consumption issue	- Fix for side effect of 77 FW item#1 which is 'Improve FA debug feature: Support UART feature'. After PM, device internally woke up and send UART signal, and this increased power consumption.	Middle
2	Fix FW for read performance fluctuation on CDM	- Related on 77rev FW change item#4, re-arranging block list should be done with optimized read level setting parallel. (Need to re-arrange block list to make the block list be correct). During this re-arranging operation, there is FW bug which is wrongly calculate of list size, and this FW bug caused to set wrong NAND read level.	Low

■ Issue: High power consumption observed at Modern Standby

■ Root cause

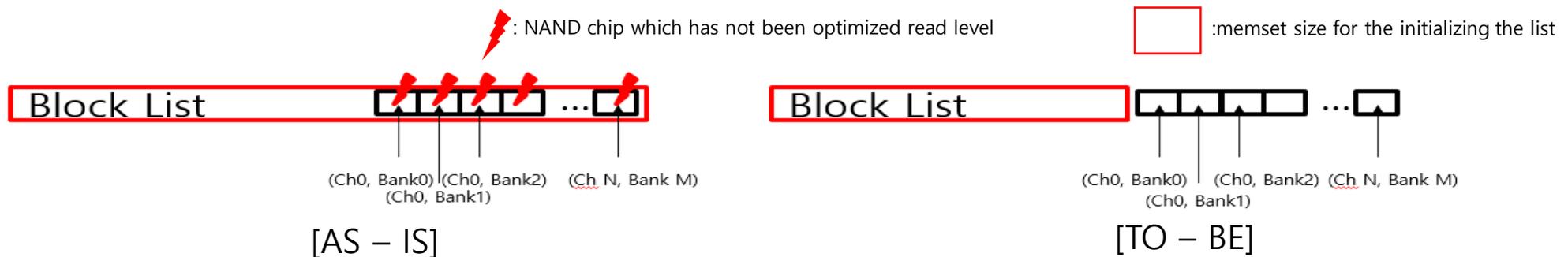
- It is verified to be side effect of 77 FW item which is 'Improve FA debug feature: Support UART feature'
- While trying to enter power mode, FW mis-knew as if host UART command is triggered and stopped to enter power mode, and this increased power consumption



■ Corrective Action

- Fix the wrong setting for FW mis-knew

- Issue : Read Performance fluctuation @ CDM
- Root-cause : Read Level optimization step can be skipped from side-effect of fixing #4 @77FW
- Failure scenario
 - The re-arranging block list should be done during optimized read level setting parallel.
 - During Read level optimizing, in the process of initializing the list by using memset, due to a list size calculation error, the read level related FW meta information is corrupted.
 - So the NAND chip which has not been optimized read level is considered as the one which is already optimized read level.
 - Therefore, the read performance drop happened because when the block which has not been optimized read level is used and it causes protection code looping execution.
- Corrective Action
 - To fix error code - memset size



■ FW change List

- Samsung would like to improve FW Quality through FW Change notification.

No.	Item	Change item	Risk Assessment
1	Improve FA debug feature	<ul style="list-style-type: none"> - Support UART feature - Adding debug logging feature 	Low
2	added FW W/A to improve AFC circuit malfunction of CTRL	<ul style="list-style-type: none"> - Add 2 times AFC circuit retry code when AFC circuit work abnormally If AFC circuit work abnormally, the FW initializes AFC circuit after 10ms and 15ms	Low
3	Optimized Unmap range	<ul style="list-style-type: none"> - # of LPN per Unmap Range needs change : Total # of LPN per Device (GXA7402Q) -> 1000 (GXA7602Q) -> 10000 (GXA7702Q)	Low
4	Fix FW <ul style="list-style-type: none"> - SLC compaction victim block 	<ul style="list-style-type: none"> - When exit PM(power management mode), FW only check whether the F/G SSB Compaction Victim exists and do not remove it from the list(Fixed FW) 	Low
5	Fixed LTR Latency value Register Structure	(Device internal) Register Mapping of FW Header is fixed. <ul style="list-style-type: none"> - It is affected to below Message TLP. Register mapping related to Snoop/No-snoop latency of device FW Header was reversed. - [R←][Msg][LTR][Snoop : --][No-snoop : --] 	Low

- **Purpose: More debug features and save to NAND in case of POR**
 - To enhance Debug feature to get more information
 - Command history/ Event ,interrupt log
 - Add debug log to have rich contents for FA
- **To save the failure information to NAND (for retrieving the logs from NAND even POR case)**
 - Customer VOC: The retention of dump log on the SSD after power down (e.g. system shutdown after SSD failure)

Category	Item	Detail	Remark
PCIe Link failure	HCORE	NVME Feature Context	<ul style="list-style-type: none"> - PCIe Error count - Interrupt log - Event log - Exception log - Host Command history - SQ/CS Head/Tail Doorbell - Link Down history - NAND information
		Event Logger	
	PCIe SFR	PCIe SFR	
	Event Data	PCIe Trace Buffer	
	NVMe SFR	Host Command Info	
		Controller Register Info	
		Submission/Completion Q SFR	
NAND failure	Debug Level	Program order	
		Host/ Interval	
		Get Feature	
		Status Read Info	

※ SFR : Special Function Register

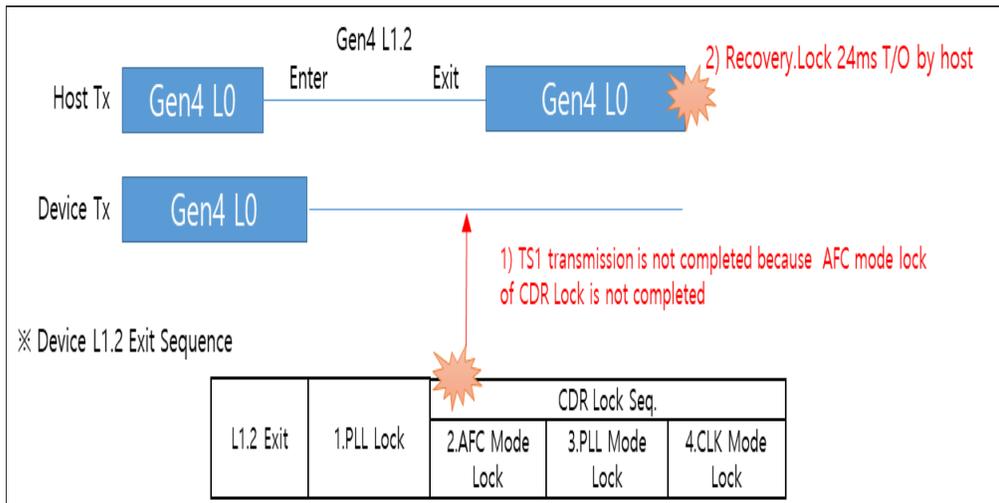
■ Issue

- Found Recovery.Lock 24ms Timeout when exit L1.2 during Modern standby testing

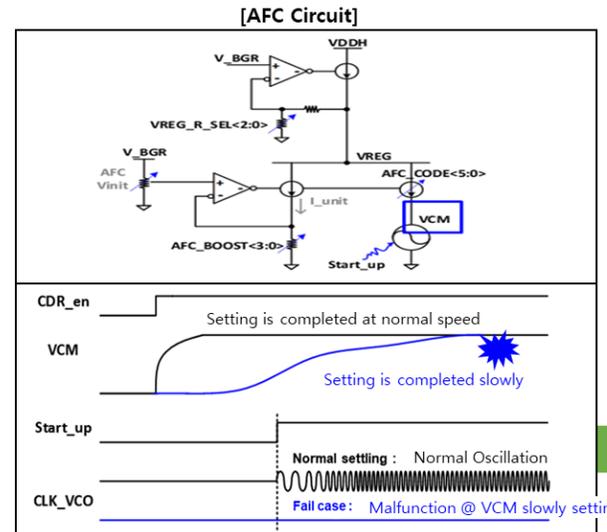
■ Root cause (failure mechanism)

- Device couldn't send TS1 (training Sequence 1) to Host and finally Recovery.Lock 24ms Timeout occurred and Link down happened
- When exit L1.2, CDR (Clock and Data Recovery) Lock of CTRL is not properly completed [Fig 1]
- The slow completion of VCM(Reference voltage of VCO in AFC circuit) settling was observed with very low probability during the AFC Sequence
- VCO(Clock oscillation circuit) malfunctioned due to the slow completion of VCM settling at fail samples

[Fig 1]



[Fig 2]



[Fail Mechanism]

- 1) SSD exit L1.2
- 2) VCM settling slowly during AFC @ Fail samples
- 3) VCO oscillator malfunctioned due to VCM settling
- 4) Can not meet target Frequency during AFC

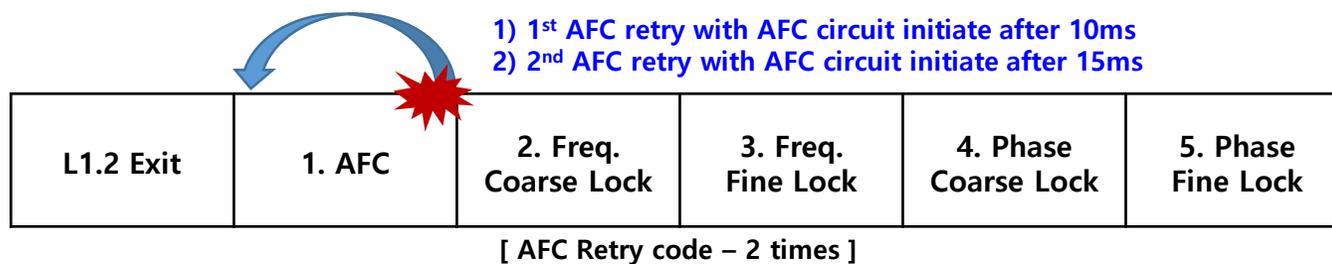
■ Corrective action

- Improvement Action

- Team added W/A point to improve AFC circuit malfunction

- ✓ Add 2 times AFC circuit retry code when AFC circuit work abnormally

So, If AFC circuit work abnormally, the FW initializes AFC circuit after 10ms and 15ms

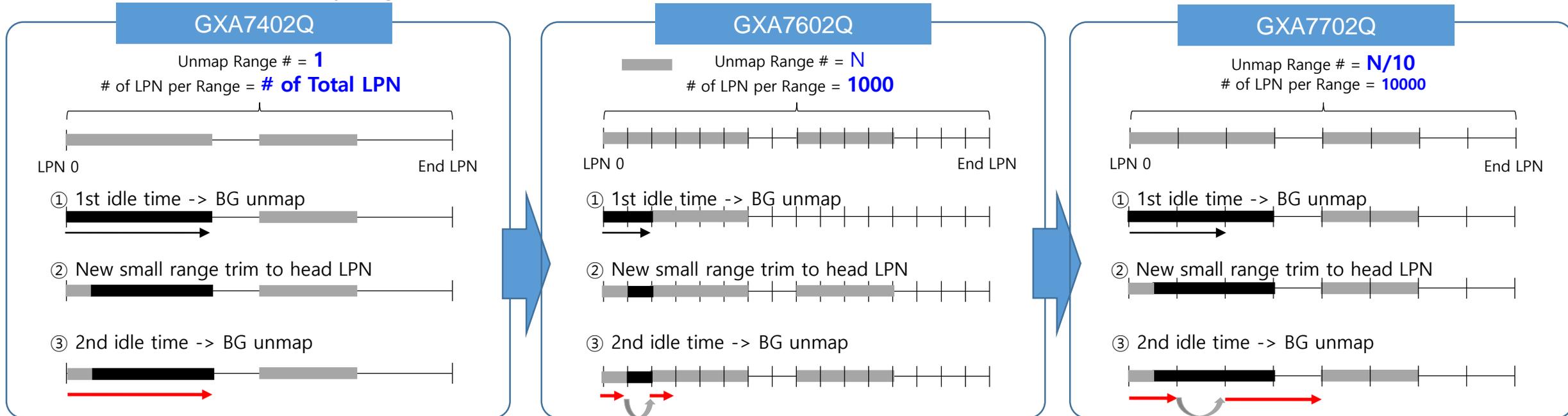


■ Issue

- SW encryption time takes so long

■ Root cause

- It is related to side effect from previous Change item(Unmap process optimization)
- Splitting # of LPN per Unmap Range was essential to guarantee to enter PM, but # was excessively small @ GXA7602Q
- FW handling time for Unmap are lengthened → Free Blocks are generated more slowly
→ Ratio of unnecessary Migration & TLC write is increased



■ Corrective action

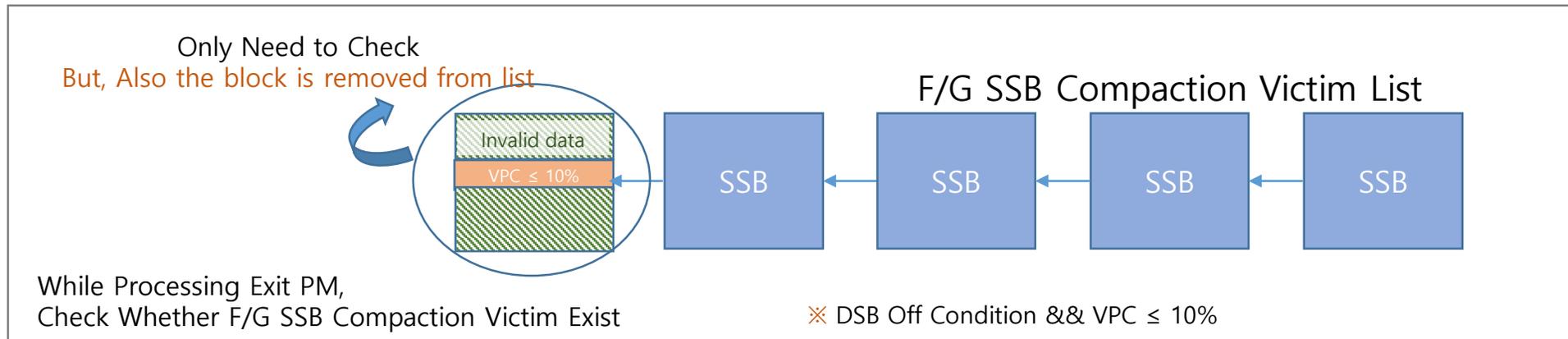
- # of LPN per Unmap Range needs change : Total # of LPN per Device (GXA7402Q) -> 1000 (GXA7602Q) -> 10000 (GXA7702Q)

■ Issue

- Seq Write performance was dropped after long idle

■ Root cause

- In DSB Off state, Foreground SSB Compaction(a kind of garbage collection) is executed to receive all write data from CDM to SSB as SLC area.
- FW checks the existence of the target block for F/G SSB Compaction in the process of checking whether there is a target SSB to perform F/G SSB Compaction after Exit PM – (Select list for Victim block)
- But FW removed the target block checked from the Compaction Victim List.
- SSB Free block cannot be created because the target block is not selected as Victim of F/G SSB Compaction,
- Finally, TLC write occurred because SSB doesn't have a room for write during CDM and Seq write performance showed TLC performance



■ Corrective action

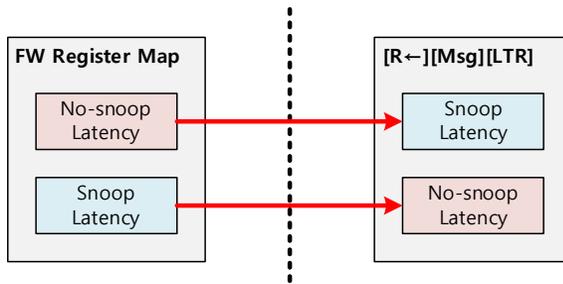
- When exit PM(power management mode), FW only check whether the F/G SSB Compaction Victim exists and do not remove it from the list.

■ Issue

- LTR Latency value Register was reversed

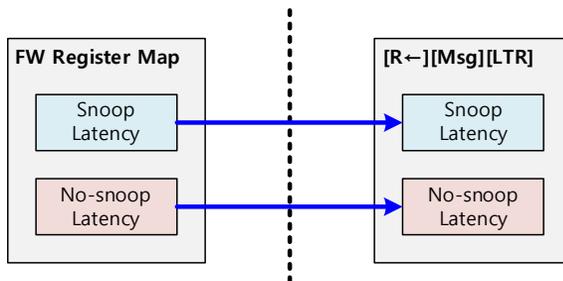
■ Root cause

- Register mapping related to Snoop/No-snoop latency of device FW Header was reversed.



■ Corrective action

- Header file of Device FW is fixed.



THE NEXT CREATION STARTS HERE

Placing **memory** at the forefront of future innovation and creative IT life

